

Features

- Floating High Side Driver with boot-strap Power supply along with a Low Side Driver.
- Fully operational to 650V
- $\pm 50\text{V/ns}$ dV/dt immunity
- Gate drive power supply range: 10 - 35V
- Undervoltage lockout for both output drivers
- Separate Logic power supply range: 3.3V to V_{CL}
- Built using the advantages and compatibility of CMOS and IXYS HDMOS™ processes
- Latch-Up protected over entire operating range
- High peak output current: 600 mA
- Matched propagation delay for both outputs
- Low output impedance
- Low power supply current
- Immune to negative voltage transients

Warning: The IXA611 is ESD sensitive.

General Description

The IXA611 is a Bridge Driver for N-channel MOSFETs and IGBTs with a high side and low side output, whose input signals reference the low side. The High Side driver can control a MOSFET or IGBT connected to a positive buss voltage up to 650V. The logic input stages are compatible with TTL or CMOS, have built-in hysteresis and are fully immune to latch up over the entire operating range. The IXA611 can withstand dV/dt on the output side up to $\pm 50\text{V/ns}$.

The IXA611 comes in either the 16-PIN SOIC package (IXA611S3) or the 14-PIN DIP through-hole package (IXA611P7)

Applications

- Driving MOSFETs and IGBTs in half-bridge circuits
- High voltage, high side and low side drivers
- Motor Controls
- Switch Mode Power Supplies (SMPS)
- DC to DC Converters
- Class D Switching Amplifiers

Figure 1. Typical Circuit Connection

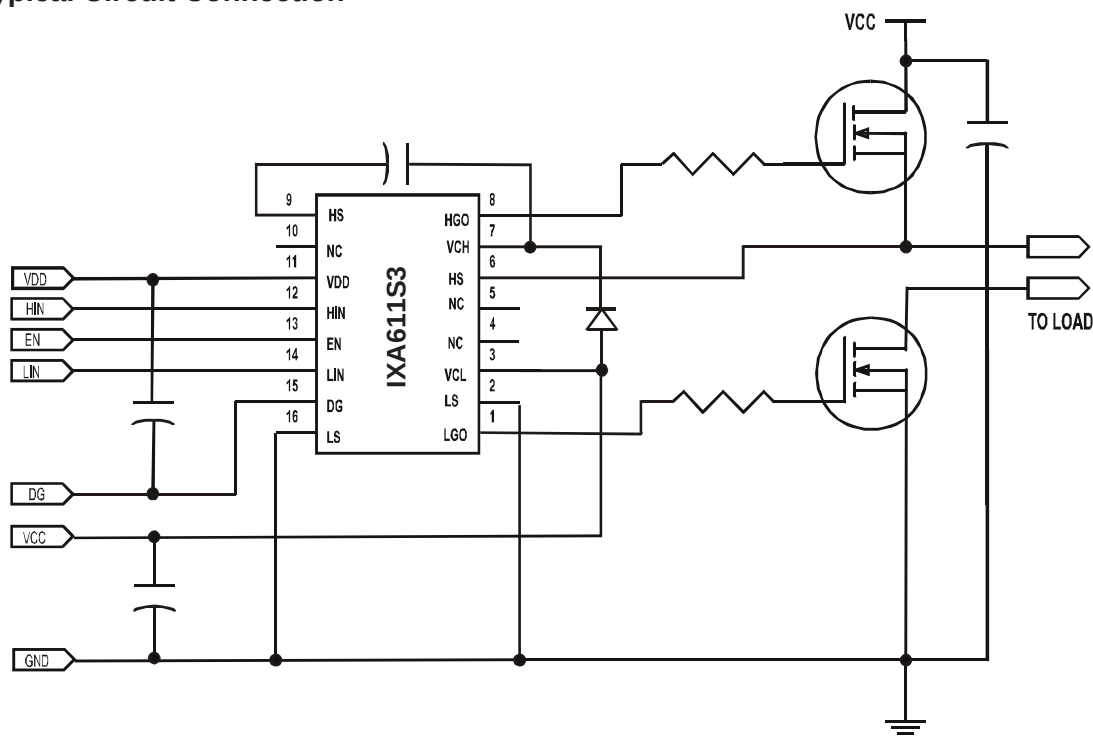
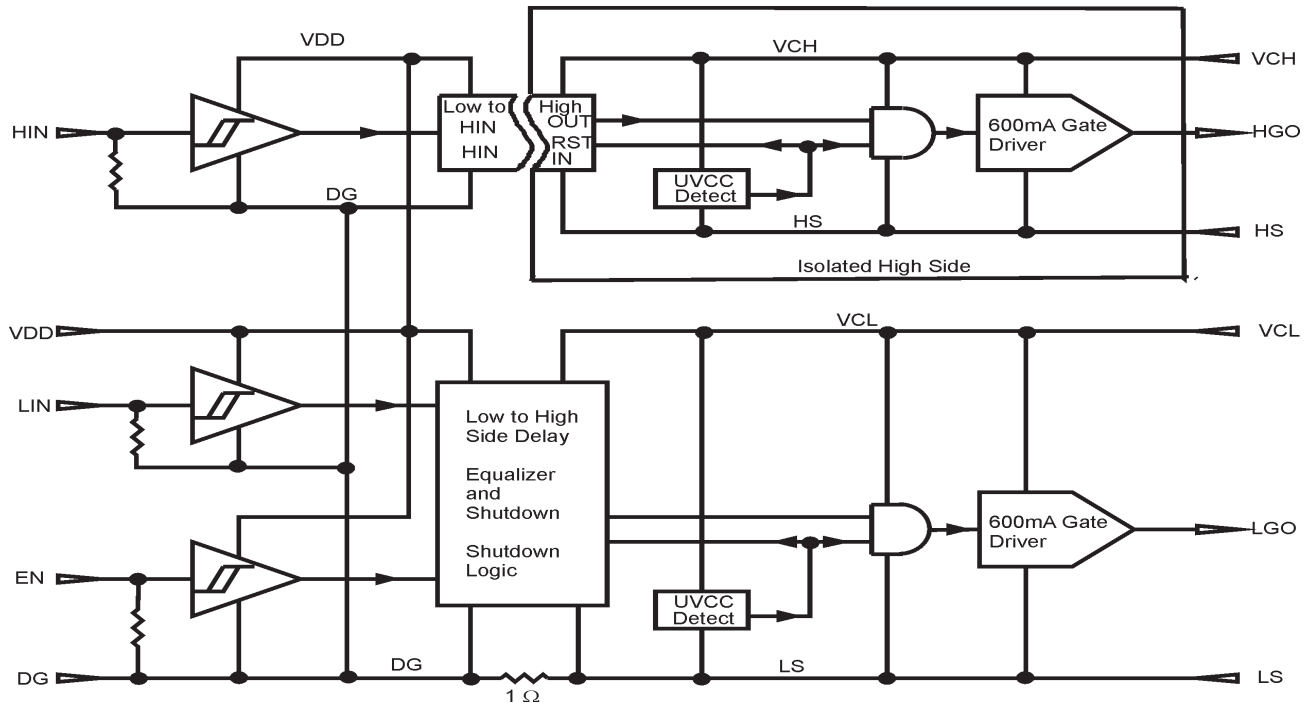
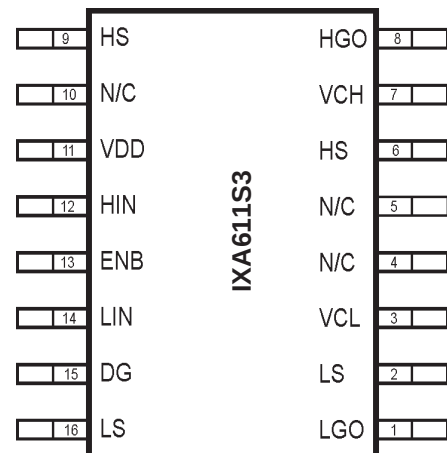
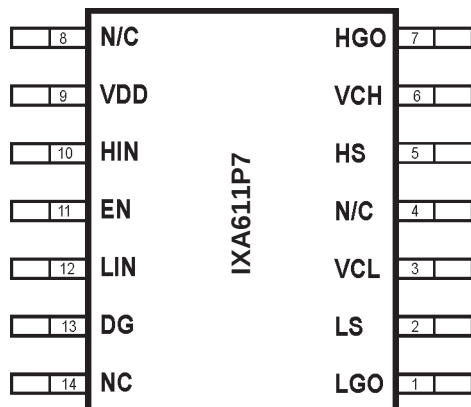


Figure 2 - IXA611 Functional Block Diagram

Pin Description And Configuration

SYMBOL	FUNCTION	DESCRIPTION
VDD	Logic Supply	Positive power supply for the chip CMOS functions
HIN	HS Input	High side Input signal, TTL or CMOS compatible; HGO in phase
LIN	LS Input	Low side Input signal, TTL or CMOS compatible; LGO in phase
ENB	Enable	Chip enable. When driven high, both outputs go low.
DG	Ground	Logic Reference Ground
VCH	Supply Voltage	High Side Power Supply
HGO	Output	High side driver output
HS	Return	High side voltage return pin
VCL	Supply Voltage	Low side power supply. This power supply provides power for both outputs. Voltage range is from 4.5 to 25V.
LGO	Output	Low side driver output
LS	Ground	Low side return



Absolute Maximum Ratings

Symbol	Definition	Min	Max	Units
V_{CH}	High side floating supply voltage	-25	650	V
V_{HS}	High side floating supply offset voltage	$V_{CH}-200$	$V_{CH}+3$	V
V_{HGO}	High side floating output voltage	$V_{HS}-3$	$V_{CH}+3$	V
V_{CL}	Low side fixed supply voltage	-0.3	35	V
V_{LGO}	Low side output voltage	-0.3	$V_{CL}+3$	V
V_{DD}	Logic supply voltage	-0.3	$V_{DG}+35$	V
V_{DG}	Logic supply offset voltage	$V_{LS}-3.8$	$V_{LS}+3.8$	V
V_{IN}	Logic input voltage(HIN & LIN)	$V_{SS}-3$	$V_{DD}+3$	V
dV_S/dt	Allowable offset supply voltage transient		50	V/ns
P_D	Package power dissipation@ $T_A \leq 25C$		1	W
P_D	Package power dissipation@ $T_C \leq 25C$		2.1	W
R_{THJA}	Thermal resistance, junction-to-ambient		125	K/W
R_{THJC}	Thermal resistance, junction-to-case		60	K/W
T_J	Junction Temperature		150	°C
T_S	Storage temperature	-55	150	°C
T_L	Lead temperature (soldering, 10 s)		300	°C

Recommended Operating Conditions

Symbol	Definition	Min	Max	Units
V_{CH}	High side floating supply absolute voltage	$V_{HS}+10$	$V_{HS}+20$	V
V_{HS}	High side floating supply offset voltage	-20	650	V
V_{HGO}	High side floating output voltage	V_{HS}	$V_{CH}+20$	V
V_{CL}	Low side fixed supply voltage	10	20	V
V_{LGO}	Low side output voltage	0	V_{CC}	V
V_{DD}	Logic supply voltage	$V_{DG}+3$	$V_{DG}+20$	V
V_{DG}	Logic supply voffset voltage	$V_{LS}-1$	$V_{LS}+1$	V
V_{IN}	Logic input voltage(HIN, LIN, ENbar)	V_{DG}	V_{DD}	V
T_A	Ambient Temperature	-40	125	°C

Ordering Information

Part Number	Package Type
IXA611P7	14-PIN DIP
IXA611S3	16-PIN SOIC

Dynamic Electrical Characteristics

Symbol	Definition	Test Conditions	Min	Typ	Max	Units
t_{on}	Turn-on propagation delay	$V_{HS} = 0V, C_{load} = 2nF$		120		ns
t_{off}	Turn-off propagation delay	$V_{HS} = 600V, C_{load} = 2nF$		87		ns
t_{en}	Device enable delay			202		ns
t_r	Turn-on rise time	$C_{load} = 2nF$		23		ns
t_f	Turn-off fall time	$C_{load} = 2nF$		22		ns
t_{dm}	Delay matching, HS & LS turn-on/off	$C_{load} = 2nF$		50		ns

Static Electrical Characteristics

Symbol	Definition	Test Conditions	Min	Typ	Max	Units
V_{INH}	Logic "1" input voltage	$V_{DD} = V_{CL} = 15V$	7.0			V
V_{INL}	Logic "0" input voltage				6	V
V_{HLGO} / V_{HHGO}	High level output voltage, $V_{CH} - V_{HGO}$ or $V_{CL} - V_{LGO}$	$I_o = 0A$		0.28		V
V_{LLGO} / V_{LHGO}	High level output voltage, V_{HGO} or V_{LGO}	$I_o = 0A$		.23		V
I_{HL}	HS to LS bias current.	$V_{HS} = V_{CH} = 600V$		.17		mA
I_{QHS}	Quiescent V_{CH} supply current	$V_{IN} = 0V$ or V_{DD}		.77		mA
I_{QLS}	Quiescent V_{CL} supply current	$V_{IN} = 0V$ or V_{DD}		.79		mA
I_{QDD}	Quiescent V_{DD} supply current	$V_{IN} = 0V$ or V_{DD}		36		uA
I_{IN}^+	Logic "1" input bias current	$V_{IN} = V_{DD}$		2		uA
I_{IN}^-	Logic "0" input voltage	$V_{IN} = 0V$		1		uA
V_{CHUV}^+	V_{CH} supply undervoltage positive going threshold.			8.3		V
V_{CHUV}^-	V_{CH} supply undervoltage negative going threshold.			8.2		V
V_{CLUV}^+	V_{CL} supply undervoltage positive going threshold			8.1		V
V_{CLUV}^-	V_{CL} supply undervoltage negative going threshold.			8.0		V
I_{GO}	HS or LS Output low short circuit current; $V_{GO} = 15V, V_{IN} = 0V, PW < 10\mu s$			± 0.6		A

Timing Waveform Definitions

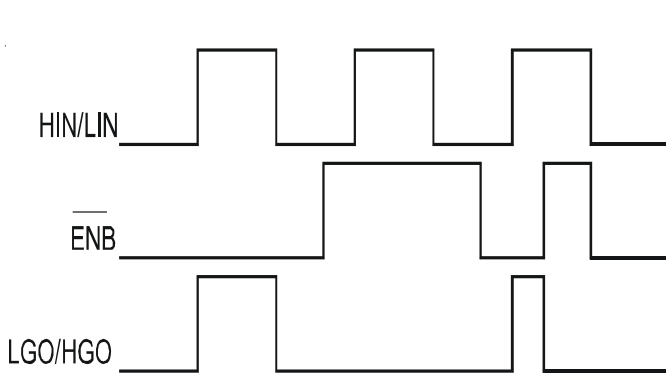


Figure 3. INPUT/OUTPUT Timing Diagram

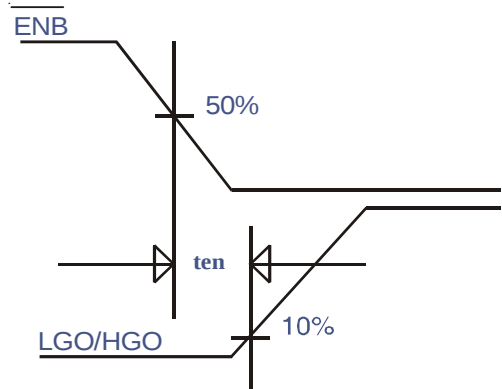
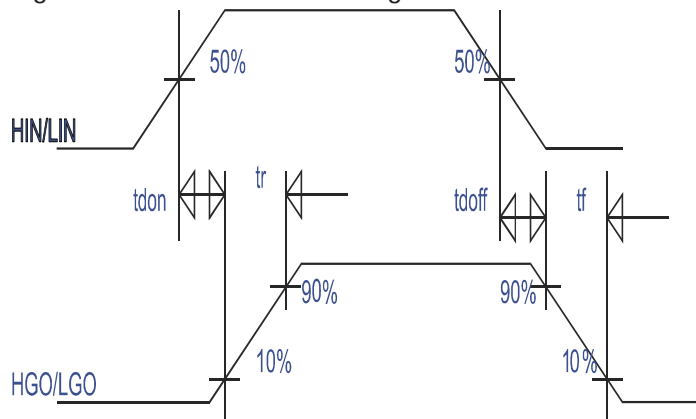


Figure 4. ENABLE Waveform Definitions

Figure 5. Definitions of Switching Time Waforms



The figure displays two timing diagrams, one for the LOW SIDE and one for the HIGH SIDE, illustrating the relationship between the LIN (Low Side Input) and LGO (Low Side Output) signals, and the HIN (High Side Input) and HGO (High Side Output) signals. The signals are shown as square waves with a 50% duty cycle. The timing parameters are defined by the width of the pulses and the time between the rising and falling edges of the signals.

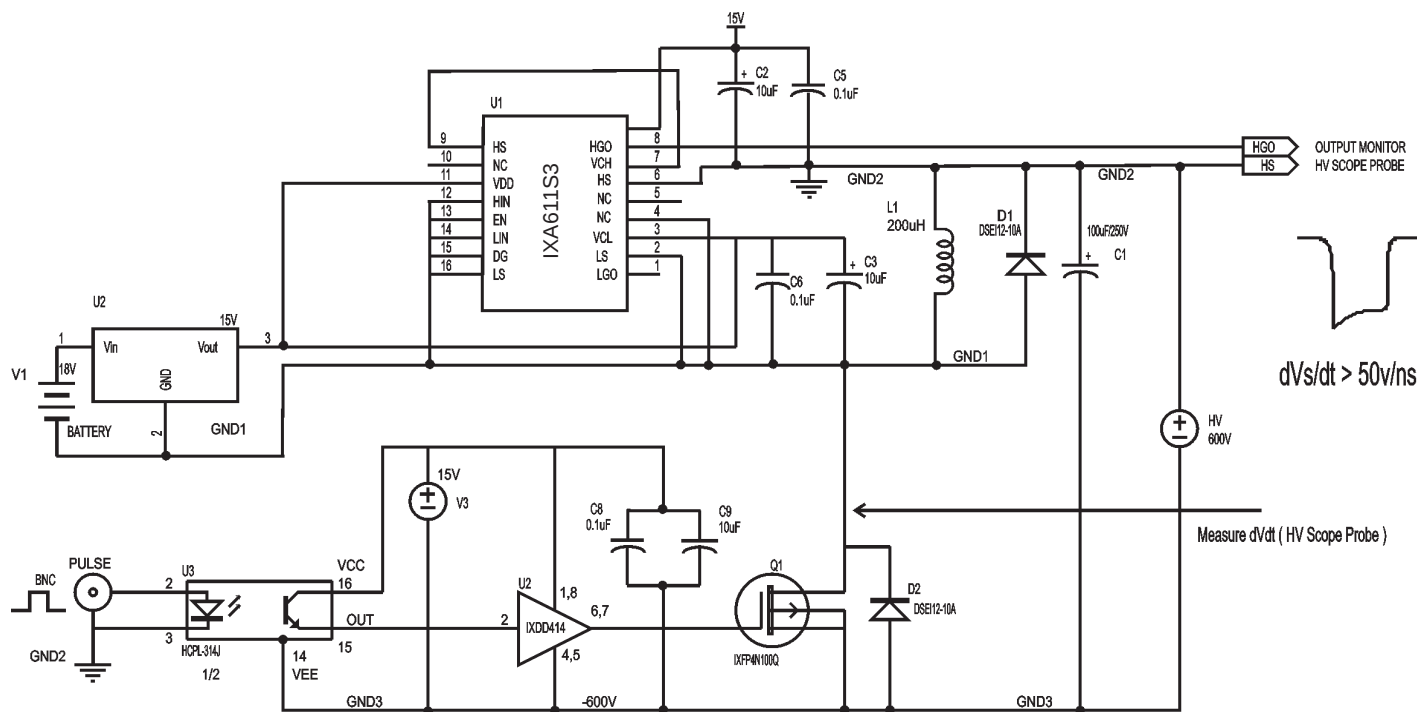
LOW SIDE:

- The LIN signal is a square wave with a 50% duty cycle.
- The LGO signal is a square wave with a 50% duty cycle, delayed relative to LIN.
- The timing parameter $tenb$ is indicated by the time between the rising edge of LIN and the rising edge of LGO.

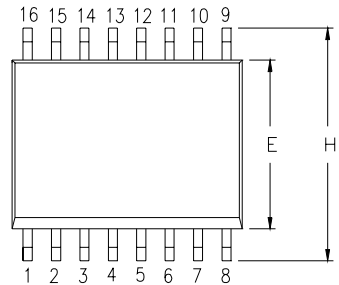
HIGH SIDE:

- The HIN signal is a square wave with a 50% duty cycle.
- The HGO signal is a square wave with a 50% duty cycle, delayed relative to HIN.
- The timing parameter $tenb$ is indicated by the time between the rising edge of HIN and the rising edge of HGO.

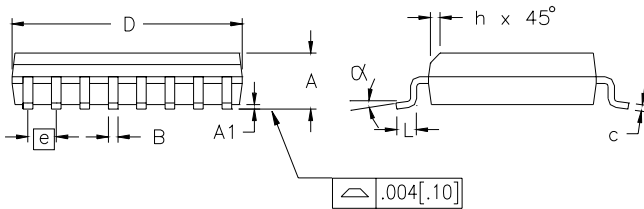
Figure 7. Test circuit for allowable offset supply voltage transient.



IXA611S3 Package Outline

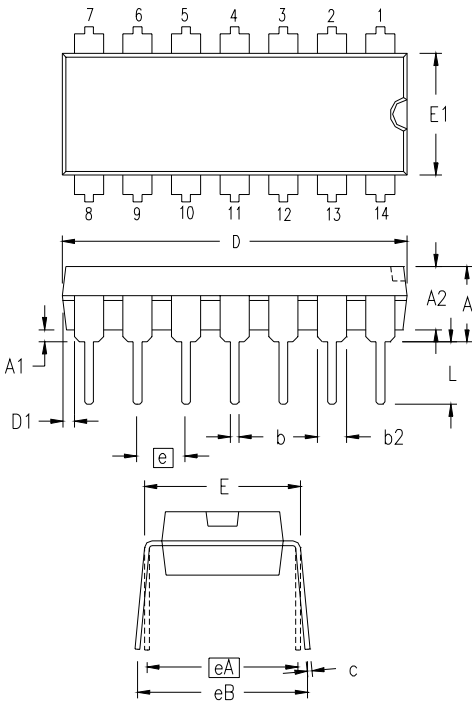


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.093	.104	2.35	2.65
A1	.004	.012	.10	.30
B	.013	.020	.33	.51
C	.009	.013	.23	.32
D	.398	.413	10.10	10.50
E	.291	.299	7.40	7.60
e	.050BSC		1.27BSC	
H	.394	.419	10.00	10.65
h	.010	.029	.25	.75
L	.016	.050	.40	1.27
α	0°	8°	0°	8°



NOTE: This drawing will meet all dimensions requirement of JEDEC MS-013 AA.

IXA611P7 Package Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.140	.180	3.56	4.57
A1	.015	.040	0.38	1.02
A2	.125	.145	3.18	3.68
b	.015	.020	0.38	0.51
b2	.055	.065	1.40	1.65
c	.009	.012	0.23	0.30
D	.735	.775	18.67	19.69
D1	.005	.040	0.13	1.02
E	.300	.325	7.62	8.26
E1	.240	.270	6.10	6.86
e	.100 BSC		2.54 BSC	
eA	.300 BSC		7.62 BSC	
eB	.300	.430	7.62	10.92
L	.120	.140	3.05	3.56

NOTE: THIS DRAWING MEETS ALL REQUIREMENT OF JEDEC OUTLINES MS-001 AA.

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